Product / Process Change Notification



N° 2017-040-A

Dear Customer.

Please find attached our INFINEON Technologies PCN:

Introduction of additional wafer production site with 12" Wafer diameter for IGBT4 1200V (T4) and IGBT HighSpeed 3 (H3) technology.

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 30. May 2017.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG

Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0

Chairman of the Supervisory Board: Wolfgang Mayrhuber

Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck

Registered Office: Neubiberg Commercial Register

Amtsgericht München HRB 126492

2017-04-18 Page 1 of 2

Product / Process Change Notification



2017-040-A

▶ Products affected: **Sales Name** SP N° **OPN Package**

1200V IGBT4 Modules

Please refer to attached affected product list 1_cip17040a

Detailed Change Information:

Subject: Introduction of additional wafer production site with

- 12" inch (300mm) wafer diameter capability for IGBT Chips

Reason: Capacity extension and increasing security of supply 1200V IGBT4 and

IGBT HighSpeed 3

For IGBT products 12" wafer manufacturing technology is meanwhile the

established technology at IFX

<u>Old</u> **Description:**

IGBT

8" inch: - Front end Villach/ Austria

- Front end Kulim/ Malaysia

New

■ IGBT

8" inch: - Front end Villach, Austria

Front end Kulim/ Malaysia

12" inch:

- Front end Dresden/ Germany

→Target production site front end Dresden/ Germany 12" inch

Product Identification: Individual module material number.

See attached list of affected products 1_cip17040a

No impact on electrical performance. Quality and reliability verified by Impact of Change:

qualification. There is no change in form, fit and function

There is no change in the assembly process at Infineon.

Attachment: Affected product list 1_cip17040a

Time Schedule:

Final qualification report: On request

First samples available: On request

Intended start of delivery: 01-Sept-2017 or directly after customer approval

If you have any questions, please do not hesitate to contact your local Sales office.

2017-04-18 Page 2 of 2